

Features

- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

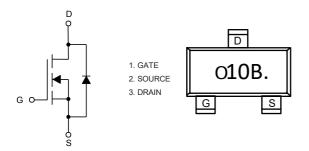
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 105°C/W Junction to Ambient (Note 2)

Parameter	Symbol	Rating	Unit		
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Volltage		V _{GS}	±16	V	
Continuous Drain Current	T _A =25°C	. I _D	3	A	
	T _A =100°C		1.9		
Pulsed Drain Current (Note 3)		I _{DM}	12	Α	
Total Power Dissipation (Note 4)		P _D	1.2	W	

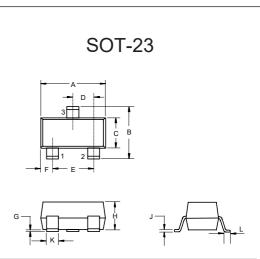
Note

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code

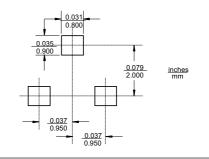


N-CHANNEL MOSFET



	DIMENSIONS				
DIM INCH		HES MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOIL
Α	0.110	0.120	2.80	3.04	
В	0.083	0.104	2.10	2.64	
С	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
Н	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

Suggested Solder Pad Layout





Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics					1	1	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	60			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±16V			±100		
		V _{DS} =0V, V _{GS} =±10V			±50	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μA	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.5	0.9	1.3	V	
Drain-Source On-Resistance		V _{GS} =10V, I _D =3A		67	100		
	$R_{DS(on)}$	V _{GS} =4.5V, I _D =3A	70 120		120	mΩ	
Gate Resistance	R _g	f=1 MHz, Open drain		2		Ω	
Forward Tranconductance	9 FS	V _{DS} =15V, I _D =2A		13		S	
Diode Characteristics							
Continuous Body Diode Current	Is				3	А	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =3A			1.2	V	
Reverse Recovery Time	t _{rr}	- I _F =1.5A,di/dt=530A/μs		6.6		ns	
Reverse Recovery Charge	Q_{rr}	- 1.5A,α//α(-550A/μS		9.1		nC	
Dynamic Characteristics							
Input Capacitance	C _{iss}			638			
Output Capacitance	C _{oss}	V_{DS} =30V, V_{GS} =0V,f=1MHz		25		pF	
Reverse Transfer Capacitance	C _{rss}			21			
Total Gate Charge	Q_g			16			
Gate-Source Charge	Q_{gs}	V _{DS} =30V,V _{GS} =10V,I _D =3A		1.3		nC	
Gate-Drain Charge	Q_{gd}			2.4			
Turn-On Delay Time	t _{d(on)}			2.1			
Turn-On Rise Time	t _r	V _{DS} =30V, V _{GS} =10V,		14		- ns	
Turn-Off Delay Time	t _{d(off)}	$R_G=2.2\Omega, I_D=1.5A$		21			
Turn-Off Fall Time	t _f			1.7			



Curve Characteristics

Fig.1 - Typical Output Characteristics

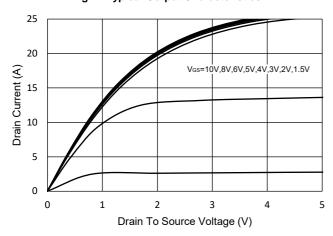


Fig.2 - Transfer Characteristic

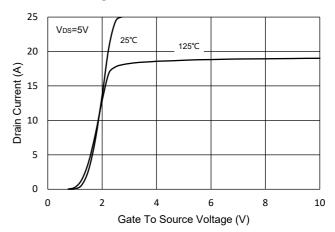


Fig.3 - R_{DS(ON)} - V_{GS}

400

CE 350

350

0 2 4 6 8 10

Gate To Source Voltage (V)

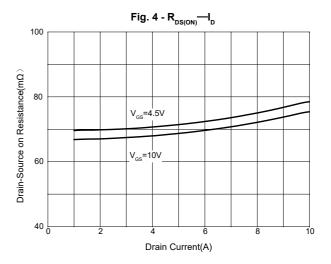


Fig.5 - Capacitance Characteristics

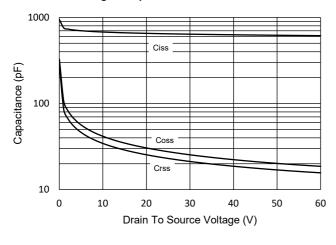
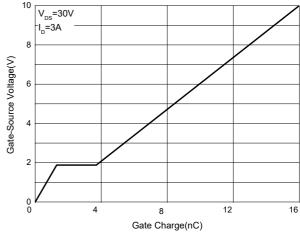


Fig. 6 - Gate Charge





Curve Characteristics

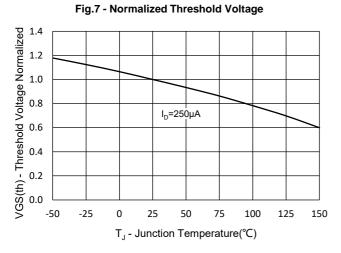


Fig.8 - Normalized On Resistance Characteristics

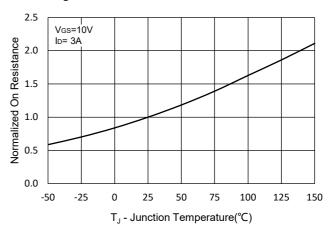


Fig.9 - I_S - V_{SD}

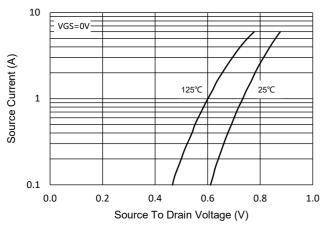


Fig. 10 - Drain Current

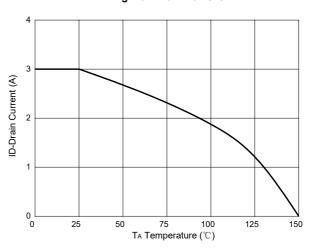
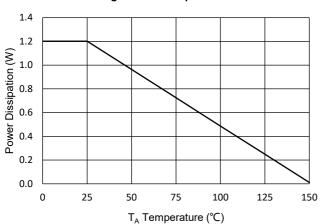


Fig.11 - PD Dissipation





Curve Characteristics

Fig.12 - Safe Operation Area

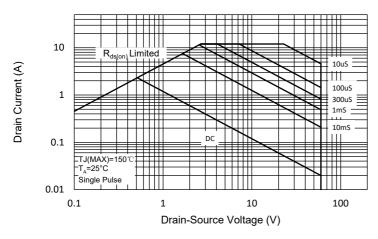
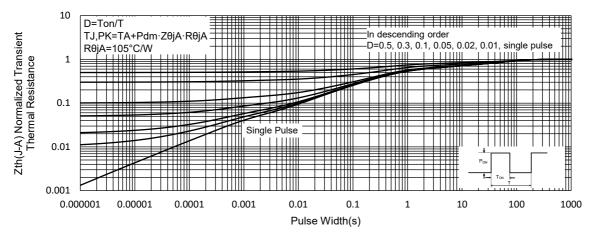


Fig.13 - Normalized Transient Thermal Impedance





Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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